

Express Mail Label No. ET037098025US

Page 1 of 3

Docket No.  
50060-00040

## Declaration For Patent Application

### English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**METHOD FOR MAKING A MICROSTRUCTURE BY SURFACE MICROMACHINING**

the specification of which

(check one)

☒ is attached hereto.

☐ was filed on \_\_\_\_\_ as United States Application No. or PCT International Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) or Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Priority Not Claimed

\_\_\_\_\_  
(Number)

\_\_\_\_\_  
(Country)

\_\_\_\_\_  
(Day/Month/Year Filed)

☐

\_\_\_\_\_  
(Number)

\_\_\_\_\_  
(Country)

\_\_\_\_\_  
(Day/Month/Year Filed)

☐

\_\_\_\_\_  
(Number)

\_\_\_\_\_  
(Country)

\_\_\_\_\_  
(Day/Month/Year Filed)

☐

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

I hereby claim the benefit under 35 U. S. C. Section 120 of any United States application(s), or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, CFR Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Status)  
(patented, pending, abandoned)

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Status)  
(patented, pending, abandoned)

\_\_\_\_\_  
(Application Serial No.)

\_\_\_\_\_  
(Filing Date)

\_\_\_\_\_  
(Status)  
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor  
**JEFFRY J. SNEGOWSKI**

Signature of first inventor's signature

*Jeffrey J. Snegowski*

Date

23 APR 01

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**M. STEVEN RODGERS**

Signature of second inventor's signature

*M. Steven Rodgers*

Date

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Full name of third inventor, if any

Third inventor's signature

Date

Residence

Citizenship

Post Office Address

Full name of fourth inventor, if any

Fourth inventor's signature

Date

Residence

Citizenship

Post Office Address

## POWER OF ATTORNEY

On behalf of MEMX, Inc., a Delaware corporation, having a principal place of business at 5600 Wyoming Blvd., Suite 20, Albuquerque, NM 87111, being the assignee of and owning all right, title and interest in the invention entitled "METHOD FOR MAKING A MICROSTRUCTURE BY SURFACE MICROMACHINING", for which application for Letters Patent of the United States has been made by Jeffrey J. Sniegowski of 67 Cactus Ranch Road, Edgewood, NM 87015, and M. Steven Rodgers of 12216 Papaya Ct. NE, Albuquerque, NM 87111, said application being identified as Attorney File No. 50060-00040, and executed on even date herewith, the undersigned, on behalf of MEMX, Inc., appoints all attorney and agents associated with Customer Number 25231 as attorneys and agents for MEMX, Inc., with full powers of substitution, association and revocation to prosecute the application and related U.S. and foreign applications and to transact all business in the United States Patent and Trademark Office and all foreign and international patent offices connected therewith.

The undersigned, on behalf of MEMX, Inc., authorizes all correspondence relating to the above-noted patent application to be direct to the correspondence address associated with Customer Number 25231.

The undersigned (whose title is supplied below) is empowered to act on behalf of MEMX, Inc.

Date: 23 Apr 01

By: [Signature]

Print Name: Michael D. McIntosh

Title: CEO Memx, Inc

MEMX, Inc.

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